

# **Additional Information**







Accessories



Samples

# **Description**

Littelfuse 16R Series Radial Leaded PTCs are designed to provide resettable overcurrent protection serving a wide range of electronics applications. With maximum 16 volts and maximum 100-ampere short circuit rating, they offer an ideal solution for USB protection.

### **Features & Benefits**

- 100A short circuit rating
- 16V Operating voltages
- Fast time-to-trip
- Meets all USB protection requirements
- RoHS compliant, Lead- Free and Halogen-Free\*

# **Applications**

- Computers & peripherals
- Any USB application
- General Electronics

#### **Agency Approvals**

| Agency            | Agency File Number |
|-------------------|--------------------|
| c <b>'RL</b> ° us | E74889             |
| $\triangle$       | R72161783          |

#### **Electrical Characteristics**

|             |      |      | V                         |     | D tun                      | Maximum        | Time To Trip   | Resis    | tance                    | Agency A          | pprovals |
|-------------|------|------|---------------------------|-----|----------------------------|----------------|----------------|----------|--------------------------|-------------------|----------|
| Part Number | (A)  | (A)  | V <sub>max</sub><br>(Vdc) | (A) | P <sub>d</sub> typ.<br>(W) | Current<br>(A) | Time<br>(Sec.) | R<br>(Ω) | R <sub>1max</sub><br>(Ω) | c <b>91</b> 2° us | <b>A</b> |
| 16R250G     | 2.5  | 4.7  | 16                        | 100 | 1.0                        | 12.5           | 5.0            | 0.0220   | 0.0530                   | X                 | X        |
| 16R300G     | 3.0  | 5.1  | 16                        | 100 | 2.3                        | 15.0           | 1.0            | 0.0380   | 0.0975                   | X                 | X        |
| 16R400G     | 4.0  | 6.8  | 16                        | 100 | 2.4                        | 20.0           | 1.7            | 0.0210   | 0.0600                   | X                 | X        |
| 16R500G     | 5.0  | 8.5  | 16                        | 100 | 2.6                        | 25.0           | 2.0            | 0.0150   | 0.0340                   | X                 | X        |
| 16R700G     | 7.0  | 11.9 | 16                        | 100 | 3.0                        | 35.0           | 3.5            | 0.0077   | 0.0200                   | X                 | X        |
| 16R800G     | 8.0  | 13.6 | 16                        | 100 | 3.0                        | 40.0           | 5.0            | 0.0056   | 0.0175                   | X                 | X        |
| 16R900G     | 9.0  | 15.3 | 16                        | 100 | 3.3                        | 45.0           | 5.5            | 0.0047   | 0.0135                   | X                 | X        |
| 16R1000G    | 10.0 | 17.0 | 16                        | 100 | 3.6                        | 50.0           | 6.0            | 0.0040   | 0.0102                   | X                 | X        |
| 16R1400G    | 14.0 | 23.8 | 16                        | 100 | 4.6                        | 70.0           | 9.0            | 0.0026   | 0.0064                   | X                 | X        |

Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.

- I bold = Hold current: maximum current device will pass without tripping in 20°C still air.
- $\frac{n_{trip}}{trip}$  = Trip current: minimum current at which the device will trip in 20°C still air.  $\frac{n_{trip}}{n_{trip}}$  = The device regular operation voltage
- = Maximum fault current device can withstand without damage at rated voltage ( $V_{\rm max}$ )
- $\mathbf{P}_{\mathbf{a}}$  = Power dissipated from device when in the tripped state at 20°C still air.

- $R_{min}$  = Minimum resistance of device in initial (un-soldered) state
- = Typical resistance of device in initial (un-soldered) state.  $R_{1max}^{vyp}$  = Maximum resistance of device at 20°C measured one hour after tripping.
- \* Effective February 11, 2010 onward, all 600R PTC products will be manufactured Halogen Free (HF). Existing Non-Halogen Free 600R PTC products may continue to be sold, until supplies are depleted. This change will have no effect on 600R product specifications or performance.

#### Warning

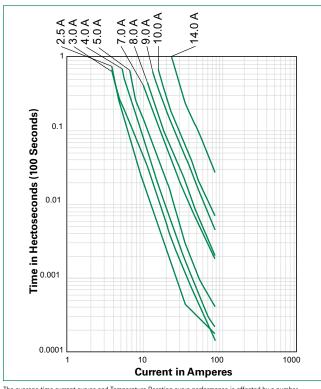
- . Users shall independently assess the suitability of these devices for each of their applications
- Operation of these devices beyond the stated maximum ratings could result in damage to the devices and lead to electrical arcing and/or fire
- These devices are intended to protect against the effects of temporary over-current or over-temperature conditions and are not intended to perform as protective devices where such conditions are expected to be repetitive or prolonged in duration
- Exposure to silicon-based oils, solvents, electrolytes, acids, and similar materials can adversely affect the performance of these PPTC devices
- These devices undergo thermal expansion under fault conditions, and thus shall be provided with adequate space and be protected against mechanical stresses
- . Circuits with inductance may generate a voltage (L di/dt) above the rated voltage of the PPTC device



### **Temperature Rerating**

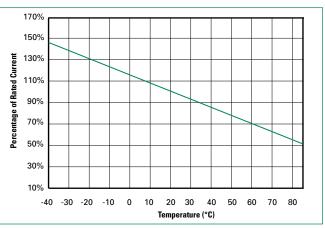
|             | Ambient Operation Temperature |                  |      |      |      |      |      |      |      |  |
|-------------|-------------------------------|------------------|------|------|------|------|------|------|------|--|
|             | -40°C                         | -20°C            | 0°C  | 20°C | 40°C | 50°C | 60°C | 70°C | 85°C |  |
| Part Number |                               | Hold Current (A) |      |      |      |      |      |      |      |  |
| 16R250G     | 3.7                           | 3.3              | 2.9  | 2.5  | 2.2  | 2.0  | 1.8  | 1.6  | 1.3  |  |
| 16R300G     | 4.4                           | 4.0              | 3.5  | 3.0  | 2.6  | 2.4  | 2.1  | 1.9  | 1.6  |  |
| 16R400G     | 5.9                           | 5.3              | 4.7  | 4.0  | 3.5  | 3.2  | 2.9  | 2.6  | 2.1  |  |
| 16R500G     | 7.4                           | 6.6              | 5.9  | 5.0  | 4.4  | 4.0  | 3.6  | 3.2  | 2.6  |  |
| 16R700G     | 10.4                          | 9.3              | 8.2  | 7.0  | 6.1  | 5.6  | 5.0  | 4.5  | 3.7  |  |
| 16R800G     | 11.8                          | 10.6             | 9.4  | 8.0  | 7.0  | 6.3  | 5.7  | 5.1  | 4.2  |  |
| 16R900G     | 13.3                          | 12.0             | 10.6 | 9.0  | 7.8  | 7.1  | 6.5  | 5.8  | 4.7  |  |
| 16R1000G    | 14.8                          | 13.3             | 11.8 | 10.0 | 8.7  | 7.9  | 7.1  | 6.4  | 5.3  |  |
| 16R1400G    | 20.7                          | 18.6             | 16.5 | 14.0 | 12.2 | 11.1 | 10.0 | 9.0  | 7.4  |  |

# **Average Time Current Curves**



The average time current curves and Temperature Rerating curve performance is affected by a number or variables, and these curves provided as guidance only. Customer must verify the performance in their application.

## **Temperature Rerating Curve**



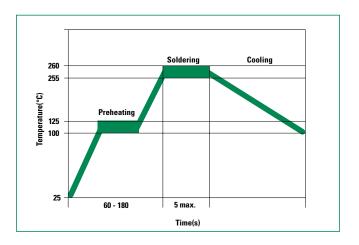
#### Note:

Typical Temperature rerating curve, refer to table for derating data



# **Soldering Parameters - Wave Soldering**

| Pre-Heating Zone | Refer to the condition recommended by the flux manufacturer. Max. ramping rate should not exceed 4°C/Sec.  |
|------------------|--|
| Soldering Zone   | Max. solder temperature should not exceed 260°C. Time within 5°C of actual Max. solder temperature within 3 - 5 seconds. Total time from 25°C room to Max. solder temperature within 5 minutes including Pre-Heating time. |
| Cooling Zone     | Cooling by natural convection in air.  Max. ramping down rate should not exceed 6°C/Sec.   |



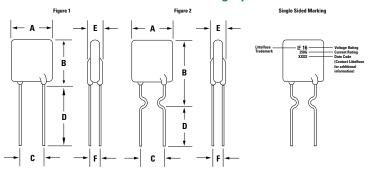
# **Physical Specifications**

| Lead Material                | 2.5A: Tin-plated Copper clad Steel<br>3.0 - 14.0A: Tin-plated Copper |
|------------------------------|--|
| Soldering<br>Characteristics | Solderability per MIL-STD-202,<br>Method 208                         |
| Insulating Material          | Cured, flame retardant epoxy polymer meets UL94V-0 requirements.     |
| Device Labeling              | Marked with 'LF', voltage, current rating, and date code             |

# **Environmental Specifications**

| Operating/Storage Temperature                          | -40°C to +85°C   |
|--|--|
| Maximum Device Surface<br>Temperature in Tripped State | 125°C  |
| Passive Aging  | +85°C, 1000 hours<br>-/+5% typical resistance change           |
| Humidity Aging   | +85°C, 85% R.H., 1000 hours<br>-/+5% typical resistance change |
| Thermal Shock  | +85°C to -40°C 10 times<br>-/+5% typical resistance change     |
| Solvent Resistance                                     | MIL–STD–202, Method 215<br>No change                           |
| Moisture Resistance Level                              | Level 1, J-STD-020   |

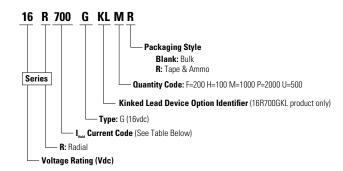
# **Dimensions & Part Marking System**



|                |        | А      |       | В      | }     | С      | ;    | D      |      | E      |      | F      |      | Physica | al Chara | acteristics |
|----------------|--------|--------|-------|--------|-------|--------|------|--------|------|--------|------|--------|------|---------|----------|-------------|
| Part<br>Number | Figure | Inches | mm    | Inches | mm    | Inches | mm   | Inches | mm   | Inches | mm   | Inches | mm   | Lead (  | dia)     | Matarial    |
| Number         |        | Max.   | Max.  | Max.   | Max.  | Тур.   | Тур. | Min.   | Min. | Max.   | Max. | Тур.   | Тур. | Inches  | mm       | Material    |
| 16R250G        | 2      | 0.35   | 8.90  | 0.50   | 12.80 | 0.20   | 5.1  | 0.13   | 3.18 | 0.12   | 3.00 | 0.035  | 0.9  | 0.020   | 0.51     | Sn/CuFe     |
| 16R300G        | 1      | 0.28   | 7.10  | 0.43   | 11.00 | 0.20   | 5.1  | 0.30   | 7.6  | 0.12   | 3.00 | 0.047  | 1.2  | 0.032   | 0.81     | Sn/Cu       |
| 16R400G        | 1      | 0.35   | 8.90  | 0.50   | 12.80 | 0.20   | 5.1  | 0.30   | 7.6  | 0.12   | 3.00 | 0.047  | 1.2  | 0.032   | 0.81     | Sn/Cu       |
| 16R500G        | 1      | 0.41   | 10.40 | 0.56   | 14.30 | 0.20   | 5.1  | 0.30   | 7.6  | 0.12   | 3.00 | 0.047  | 1.2  | 0.032   | 0.81     | Sn/Cu       |
| 16R700G        | 1      | 0.44   | 11.20 | 0.78   | 19.70 | 0.20   | 5.1  | 0.30   | 7.6  | 0.12   | 3.00 | 0.047  | 1.2  | 0.032   | 0.81     | Sn/Cu       |
| 16R800G        | 1      | 0.50   | 12.70 | 0.82   | 20.90 | 0.20   | 5.1  | 0.30   | 7.6  | 0.12   | 3.00 | 0.047  | 1.2  | 0.032   | 0.81     | Sn/Cu       |
| 16R900G        | 1      | 0.55   | 14.00 | 0.85   | 21.70 | 0.20   | 5.1  | 0.30   | 7.6  | 0.12   | 3.00 | 0.047  | 1.2  | 0.032   | 0.81     | Sn/Cu       |
| 16R1000G       | 1      | 0.65   | 16.50 | 0.99   | 25.20 | 0.20   | 5.1  | 0.30   | 7.6  | 0.12   | 3.00 | 0.047  | 1.2  | 0.032   | 0.81     | Sn/Cu       |
| 16R1400G       | 1      | 0.93   | 23.50 | 1.10   | 27.90 | 0.40   | 10.2 | 0.30   | 7.6  | 0.14   | 3.50 | 0.055  | 1.4  | 0.039   | 1.00     | Sn/Cu       |



# **Part Ordering Number System**



# **Packaging Options**

| Part Number | Ordering Number | I hold (A) | I hold Code | Packaging Option | Quantity | Quantity & Packaging Codes |
|-------------|-----------------|------------|-------------|------------------|----------|----------------------------|
| 16R250G     | 16R250GU        | 2.50       | 250         | Bulk             | 500      | U                          |
| 16R300G     | 16R300GU        | 3.00       | 300         | Bulk             | 500      | U                          |
| 1003000     | 16R300GPR       | 3.00       | 300         | Tape and Ammo    | 2000     | PR                         |
| 16R400G     | 16R400GU        | 4.00       | 400         | Bulk             | 500      | U                          |
| 1004000     | 16R400GPR       | 4.00       | 400         | Tape and Ammo    | 2000     | PR                         |
| 16R500G     | 16R500GU        | 5.00       | 500         | Bulk             | 500      | U                          |
| 10113000    | 16R500GPR       | 5.00       | 500         | Tape and Ammo    | 2000     | PR                         |
| 16R700G     | 16R700GMR       | 7.00       | 700         | Tape and Ammo    | 1000     | MR                         |
| 16R800G     | 16R800GF        | 8.00       | 800         | Bulk             | 200      | F                          |
| 16R900G     | 16R900GF        | 9.00       | 900         | Bulk             | 200      | F                          |
| 10113000    | 16R900GMR       | 3.00       | 300         | Tape and Ammo    | 1000     | MR                         |
| 16R1000G    | 16R1000GMR      | 10.00      | 1000        | Tape and Ammo    | 1000     | MR                         |
| 16R1400G    | 16R1400GH       | 14.00      | 1400        | Bulk             | 100      | Н                          |

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  Exposure to silicon-based oils, solvents, electrolytes, acids, and similar materials can adversely affect the performance of these PPTC devices
- These devices undergo thermal expansion under fault conditions, and thus shall be provided with adequate space and be protected against mechanical stresses
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# **Tape and Ammo Specifications**

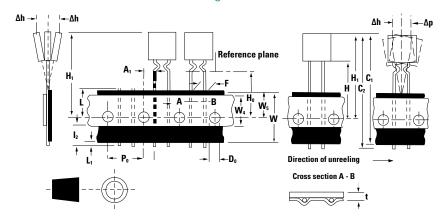
Devices taped using EIA468-B/IE286-2 standards. See table below and Figure 1 for details.

| Dimension                            | EIA Mark           | IEC Mark       | Dimensions      |             |  |  |
|--------------------------------------|--------------------|----------------|-----------------|-------------|--|--|
| Dillielision                         |                    |                | Dim. (mm)       | Tol. (mm)   |  |  |
| Carrier tape width                   | W                  | w              | 18              | -0.5 /+1.0  |  |  |
| Hold down tape width:                | $W_4$              | W <sub>o</sub> | 11              | min.        |  |  |
| Top distance between tape edges      | $W_6$              | $W_2$          | 3               | max.        |  |  |
| Sprocket hole position               | $W_{\mathfrak{s}}$ | W <sub>1</sub> | 9               | -0.5 /+0.75 |  |  |
| Sprocket hole diameter*              | D <sub>o</sub>     | D <sub>o</sub> | 4               | -0.32 /+0.2 |  |  |
| Abscissa to plane(straight lead)     | Н                  | Н              | 18.5            | -/+ 3.0     |  |  |
| Abscissa to plane(kinked lead)       | H <sub>o</sub>     | H <sub>o</sub> | 16              | -/+ 0.5     |  |  |
| Abscissa to top                      | -                  | -              | 45.0            | max.        |  |  |
| Overall width w/o lead protrusion    | -                  | -              | 56              | max.        |  |  |
| Overall width w/ lead protrusion     | -                  | -              | 57              | max.        |  |  |
| Lead protrusion                      | L,                 | I <sub>1</sub> | 1.0             | max.        |  |  |
| Protrusion of cut out                | L                  | L              | 11              | max.        |  |  |
| Protrusion beyond hold-down tape     | I <sub>2</sub>     | I <sub>2</sub> | Not specified   |             |  |  |
| Sprocket hole pitch                  | P <sub>o</sub>     | P <sub>o</sub> | 25.4            | -/+ 0.5     |  |  |
| Device pitch:                        | -                  | -              | 25.4            |             |  |  |
| Pitch tolerance                      | -                  | -              | 20 consecutive. | -/+ 1       |  |  |
| Tape thickness                       | t                  | t              | 0.9             | max.        |  |  |
| Tape thickness with splice           | t <sub>1</sub>     | -              | 2.0             | max.        |  |  |
| Splice sprocket hole alignment       | -                  | -              | 0               | -/+ 0.3     |  |  |
| Body lateral deviation               | Δh                 | Δh             | 0               | -/+ 1.0     |  |  |
| Body tape plane deviation            | Δр                 | Δр             | 0               | -/+ 1.3     |  |  |
| Ordinate to adjacent component lead* | P <sub>1</sub>     | P <sub>1</sub> | 3.81            | -/+ 0.7     |  |  |
| Ordinate to adjacent component lead* | -                  | -              | 7.62            | -/+ 0.7     |  |  |
| Lead spacing:16R250G-16R1000G        | F                  | F              | 5.08            | -/+ 0.8     |  |  |
| Lead spacing:16R1400G                | F                  | F              | 10.18           | -/+ 0.8     |  |  |

<sup>\*</sup>Differs from EIA specification

### **Tape and Ammo Diagram**

Figure 1



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